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<u>MOSFET</u> – Power, Single N-Channel, DFN5/DFNW5 60 V, 9.2 mΩ, 50 A

NVMFS5C673NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C673NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	۱ _D	50	А
Current $R_{\theta JC}$ (Notes 1, 3)		T _C = 100°C		35	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	46	W
R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$		23	
Continuous Drain	······		۱ _D	14	А
Current R _{θJA} (Notes 1, 2, 3)	Steady State	$T_A = 100^{\circ}C$		10	
Power Dissipation		T _A = 25°C	PD	3.6	W
R _{θJA} (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.8	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	290	А
Operating Junction and Storage Temperature		T _J , T _{stg}	–55 to + 175	°C	
Source Current (Body Diode)		I _S	52	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.3 A)		E _{AS}	88	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)				260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

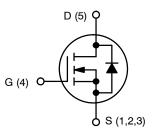
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	3.2	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	42	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
Maximum current for pulses as long as 1 second is higher but is dependent

on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	9.2 mΩ @ 10 V	50 A
	13 m Ω @ 4.5 V	30 A



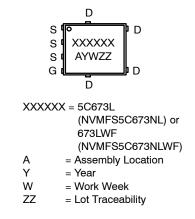




DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

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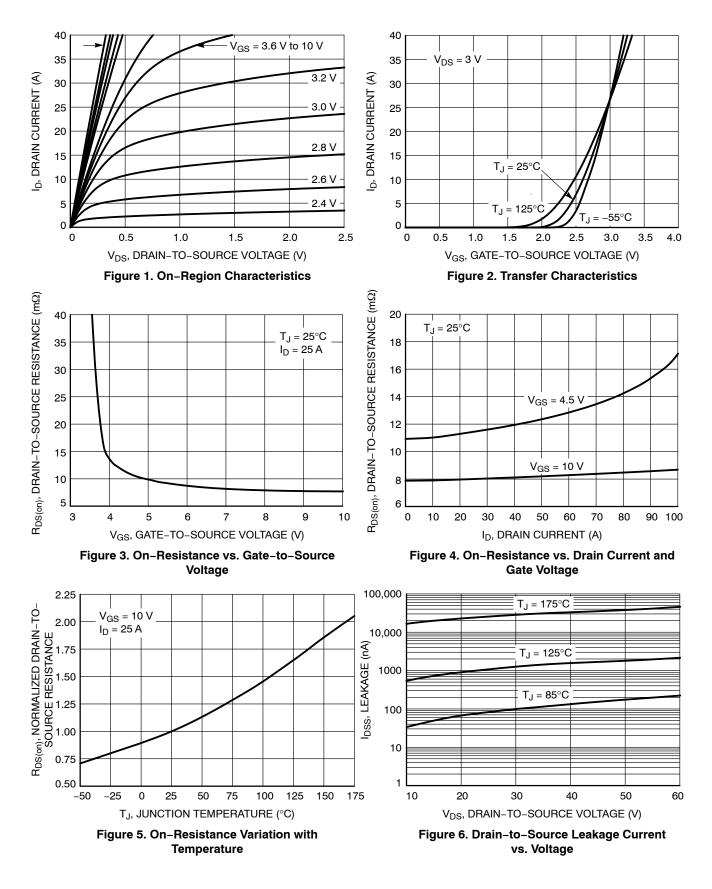
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				28		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			10	
		V _{DS} = 60 V	T _J = 125°C			μA 250	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)				-		-	-
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 35 \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 25 A		7.7	9.2	
		V _{GS} = 4.5 V	I _D = 25 A		11	13	mΩ
Forward Transconductance	9FS	V _{DS} =15 V, I _D	₀ = 25 A		37		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			880		pF
Output Capacitance	C _{OSS}				450		
Reverse Transfer Capacitance	C _{RSS}				11		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 25 A			4.5		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 25 A			9.5		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 25 A			1.0		nC V
Gate-to-Source Charge	Q _{GS}				2.0		
Gate-to-Drain Charge	Q _{GD}				0.8		
Plateau Voltage	V _{GP}				2.9		
SWITCHING CHARACTERISTICS (Note 5)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 48 V, I _D = 25 A, R _G = 2.5 Ω			6.0		ns
Rise Time	tr				25		
Turn-Off Delay Time	t _{d(OFF)}				16		
Fall Time	t _f				2.0		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	VGS = 0 V,	$T_J = 25^{\circ}C$		0.9	1.2	
			T _J = 125°C		0.8		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 25 A			28		
Charge Time	ta				14		ns
Discharge Time	t _b				14		
Reverse Recovery Charge	Q _{RR}			·	18		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

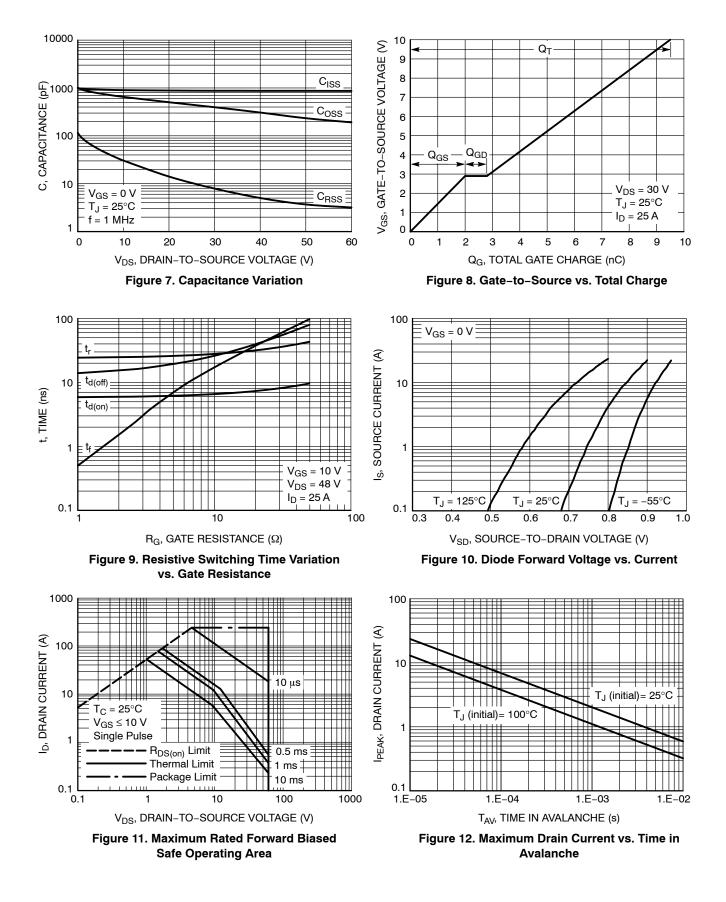
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

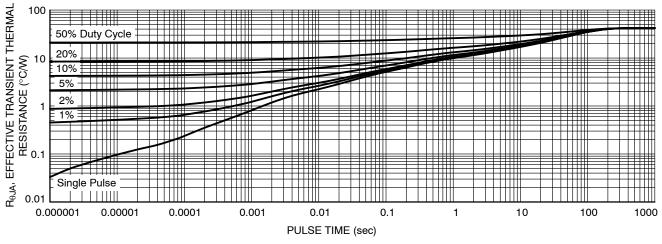


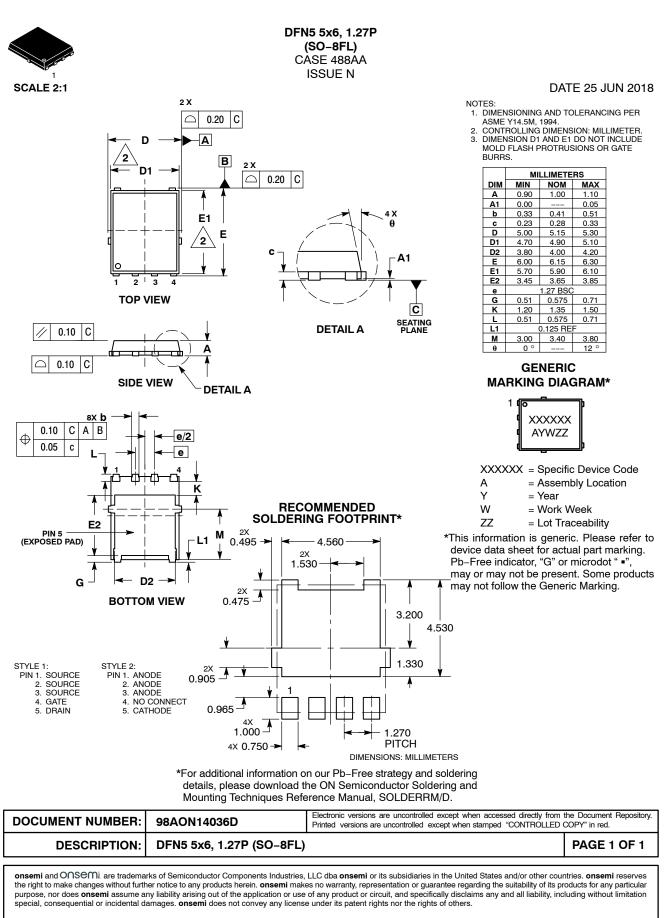
Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]	
NVMFS5C673NLT1G	5C673L	DFN5 (Pb–Free)	1500 / Tape & Reel	
NVMFS5C673NLWFT1G	673LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C673NLT3G	5C673L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C673NLWFT3G	673LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C673NLAFT1G	5C673L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C673NLAFT1G-YE	5C673L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C673NLWFAFT1G	673LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	

DEVICE ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

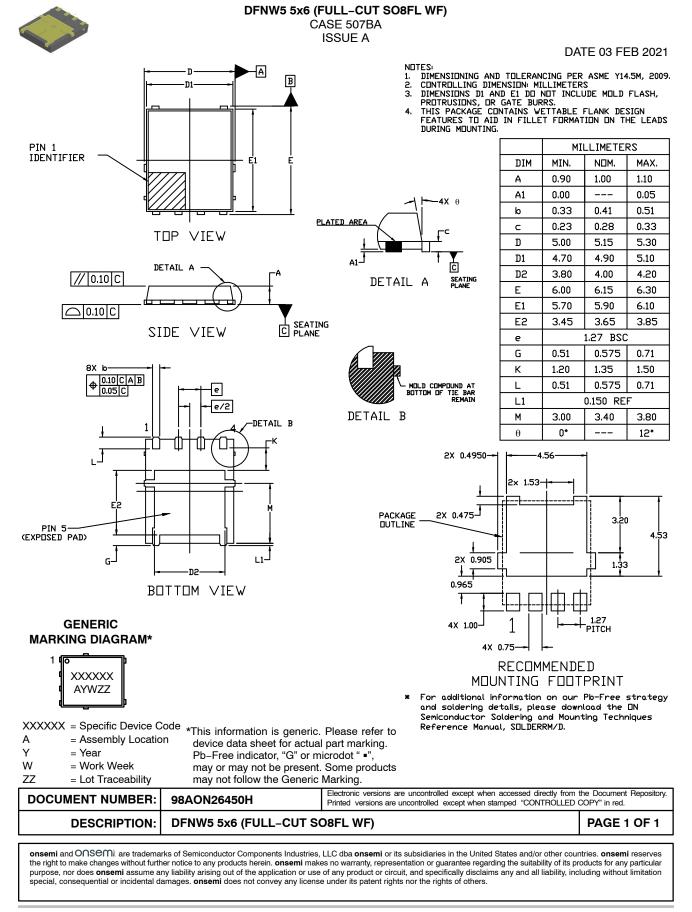
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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